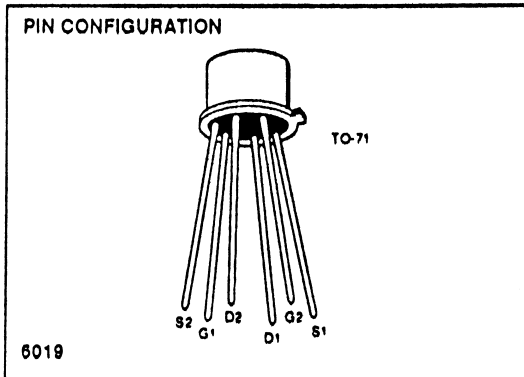


Dual N-Channel JFET Low Noise Amplifier

2N6483 - 2N6485

FEATURES

- Ultra Low Noise
- High CMRR
- Low Offset
- Tight Tracking



ABSOLUTE MAXIMUM RATINGS (TA = 25°C unless otherwise specified)

Gate-Source or Gate-Drain Voltage (Note 1)	-50V
Gate-Gate Voltage	±50V
Gate Current (Note 1)	50mA
Storage Temperature Range	-65°C to +200°C
Operating Temperature Range	-55°C to +175°C
Lead Temperature (Soldering, 10sec)	+300°C

	One Side	Both Sides
Power Dissipation	250mW	400mW
Derate above 25°C	1.7mW/°C	2.7mW/°C

NOTE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ORDERING INFORMATION

Part	Package	Temperature Range
2N6483	Hermetic TO-71	-55°C to +175°C
2N6484	Hermetic TO-71	-55°C to +175°C
2N6485	Hermetic TO-71	-55°C to +175°C
X2N6485	Sorted Chips in Carriers	-55°C to +175°C

ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise specified)

SYMBOL	PARAMETER	MIN	MAX	UNITS	TEST CONDITIONS	
I _{gss}	Gate Reverse Current		-200	pA	V _{gs} = -30V, V _{ds} = 0	TA = 150°C
			-200	nA		
BV _{GSS}	Gate Reverse Breakdown Voltage	-50		V	I _g = -1μA, V _{ds} = 0	
V _p	Gate-Source Pinch Off Voltage	-0.7	-4.0	V	V _{ds} = 20V, I _g = 1nA	
I _{oss}	Drain Current at Zero Gate Voltage (Note 2)	0.5	7.5	mA	V _{ds} = 20V, V _{gs} = 0	
g _{fs}	Common-Source Forward Transconductance (Note 2)	1000	4000		V _{ds} = 20V, V _{gs} = 0, f = 1kHz (Note 6)	
g _{oss}	Common-Source Output Conductance			μS	V _{ds} = 20V, V _{gs} = 0, f = 1kHz (Note 6)	
C _{iss}	Common-Source Input Capacitance		20	pF	V _{ds} = 20V, V _{gs} = 0, f = 1MHz (Note 6)	
C _{rss}	Common-Source Reverse Transfer Capacitance		3.5	pF	V _{ds} = 20V, V _{gs} = 0, f = 1MHz (Note 6)	
I _g	Gate Current		100	pA	V _{gs} = 20V, I _g = 200μA, (Note 6)	TA = 150°C
			100	nA		
V _{gs}	Gate Source Voltage	0.2	3.8	V	V _{ds} = 20V, I _g = 200μA	
g _{fs}	Common-Source Forward Transconductance	500	1500		V _{ds} = 20V, I _g = 200μA, f = 1kHz	
g _{os}	Common-Source Output Conductance		1	μS	V _{ds} = 20V, I _g = 200μA	
ē _n	Equivalent Input Noise Voltage (Note 6)		10	nV/√Hz	V _{ds} = 20V, I _g = 200μA, f = 10Hz	V _{ds} = 20V, I _g = 200μA, f = 1kHz
			5	nV/√Hz		

- NOTES: 1. Per transistor
2. Pulse test required; pulse width = 2ms

MATCHING CHARACTERISTICS (Continued) (TA = 25°C unless otherwise specified)

SYMBOL	PARAMETER	2N6483		2N6484		2N6485		UNITS	TEST CONDITIONS
		MIN	MAX	MIN	MAX	MIN	MAX		
I _{oss1} I _{oss2}	Drain Current Ratio at Zero Gate Voltage	0.95	1	0.95	1	0.95	1		V _{ds} = 20V, V _{gs} = 0 (Note 4)
I _{g1} - I _{g2}	Differential Gate Current		10		10		10	nA	V _{ds} = 20V, I _g = 200μA, TA = +125°C
g _{fs1} g _{fs2}	Transconductance Ratio	0.97	1	0.97	1	0.95	1		V _{ds} = 20V, I _g = 200μA, f = 1kHz (Note 4)
g _{os1} - g _{os2}	Differential Output Conductance (Note 6)		0.1		0.1		0.1	μS	V _{ds} = 20V, I _g = 200μA, f = 1kHz
V _{gs1} - V _{gs2}	Differential Gate-Source Voltage		5		10		15	mV	V _{ds} = 20V, I _g = 200μA
Δ V _{gs1} - V _{gs2} ΔT	Gate-Source Voltage Differential Drift		5		10		25	μV/°C	V _{ds} = 20V, I _g = 200μA, TA = -55°C to +125°C
CMRR	Common Mode Rejection Ratio (Note 6)	100		100		90		dB	V _{ds} = 10 to 20V, I _g = 200μA (Note 5)

